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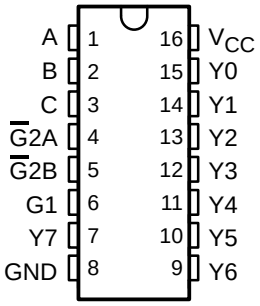
SN54AHCT138, SN74AHCT138
3-LINE TO 8-LINE DECODERS/DEMULTIPLEXERS

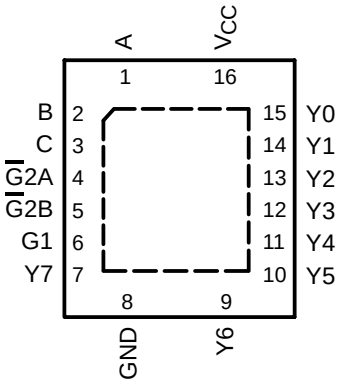
SCLS266L – DECEMBER 1995 – REVISED SEPTEMBER 2002

- **Inputs Are TTL-Voltage Compatible**
- **Designed Specifically for High-Speed Memory Decoders and Data-Transmission Systems**
- **Incorporate Three Enable Inputs to Simplify Cascading and/or Data Reception**
- **Latch-Up Performance Exceeds 250 mA Per JESD 17**
- **ESD Protection Exceeds JESD 22**
  - **2000-V Human-Body Model (A114-A)**
  - **200-V Machine Model (A115-A)**
  - **1000-V Charged-Device Model (C101)**

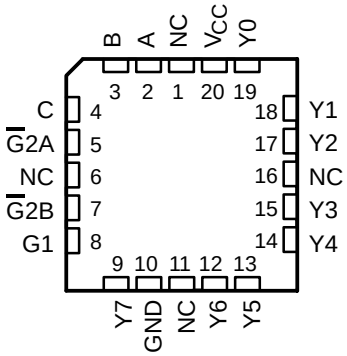
SN54AHCT138 . . . J OR W PACKAGE
SN74AHCT138 . . . D, DB, DGV, N, NS, OR PW PACKAGE
(TOP VIEW)



SN74AHCT138 . . . RGY PACKAGE
(TOP VIEW)



SN54AHCT138 . . . FK PACKAGE
(TOP VIEW)



NC – No internal connection

description/ordering information

The ’AHCT138 3-line to 8-line decoders/demultiplexers are designed to be used in high-performance memory-decoding and data-routing applications that require very short propagation-delay times. In high-performance memory systems, this decoder can be used to minimize the effects of system decoding. When employed with high-speed memories utilizing a fast enable circuit, the delay times of this decoder and the enable time of the memory usually are less than the typical access time of the memory. This means that the effective system delay introduced by the decoder is negligible.

ORDERING INFORMATION

T_A	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	QFN – RGY	Tape and reel	SN74AHCT138RGYR	HB138
	PDIP – N	Tube	SN74AHCT138N	SN74AHCT138N
	SOIC – D	Tube	SN74AHCT138D	AHCT138
		Tape and reel	SN74AHCT138DR	
	SOP – NS	Tape and reel	SN74AHCT138NSR	AHCT138
	SSOP – DB	Tape and reel	SN74AHCT138DBR	HB138
	TSSOP – PW	Tape and reel	SN74AHCT138PWR	HB138
	TVSOP – DGV	Tape and reel	SN74AHCT138DGVR	HB138
–55°C to 125°C	CDIP – J	Tube	SNJ54AHCT138J	SNJ54AHCT138J
	CFP – W	Tube	SNJ54AHCT138W	SNJ54AHCT138W
	LCCC – FK	Tube	SNJ54AHCT138FK	SNJ54AHCT138FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

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On products compliant to MIL-PRF-38535, all parameters are tested unless otherwise noted. On all other products, production processing does not necessarily include testing of all parameters.

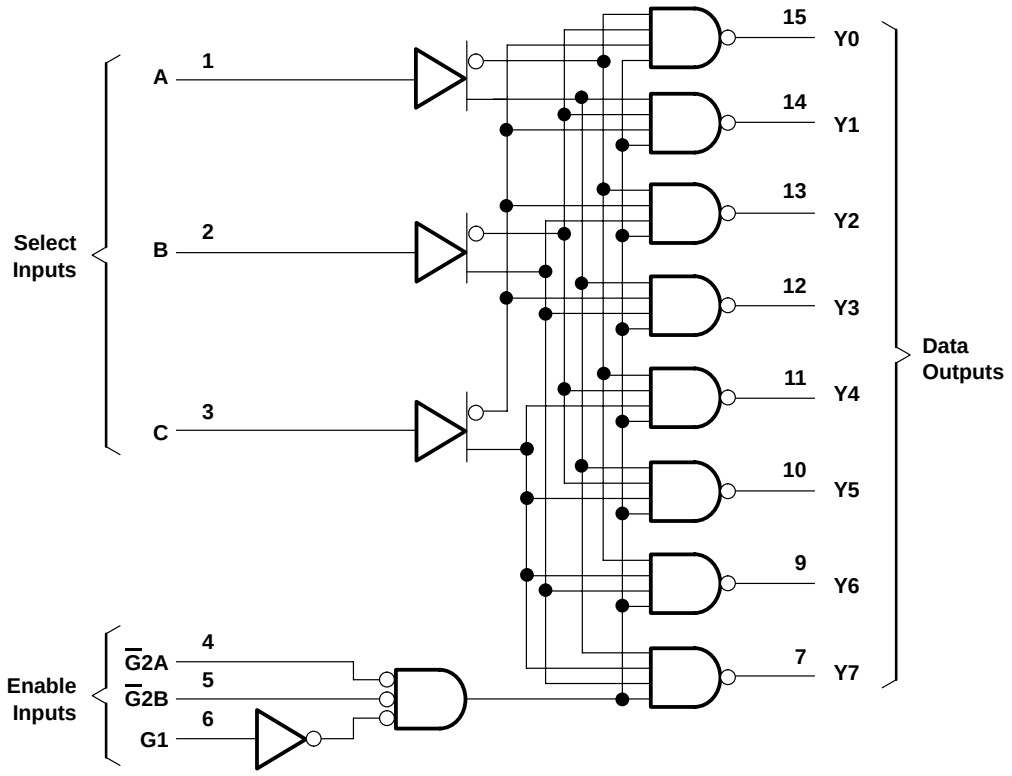
description/ordering information (continued)

The conditions at the binary-select inputs and the three enable inputs select one of eight output lines. Two active-low and one active-high enable inputs reduce the need for external gates or inverters when expanding. A 24-line decoder can be implemented without external inverters, and a 32-line decoder requires only one inverter. An enable input can be used as a data input for demultiplexing applications.

FUNCTION TABLE

ENABLE INPUTS			SELECT INPUTS			OUTPUTS							
G1	$\overline{G}$2A	$\overline{G}$2B	C	B	A	Y0	Y1	Y2	Y3	Y4	Y5	Y6	Y7
X	H	X	X	X	X	H	H	H	H	H	H	H	H
X	X	H	X	X	X	H	H	H	H	H	H	H	H
L	X	X	X	X	X	H	H	H	H	H	H	H	H
H	L	L	L	L	L	L	H	H	H	H	H	H	H
H	L	L	L	L	H	H	L	H	H	H	H	H	H
H	L	L	L	H	L	H	H	L	H	H	H	H	H
H	L	L	L	H	H	H	H	H	L	H	H	H	H
H	L	L	H	L	L	H	H	H	H	L	H	H	H
H	L	L	H	L	H	H	H	H	H	H	L	H	H
H	L	L	H	H	L	H	H	H	H	H	H	L	H
H	L	L	H	H	H	H	H	H	H	H	H	H	L

logic diagram (positive logic)



Pin numbers shown are for the D, DB, DGV, J, N, NS, PW, RGY, and W packages.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC} . . . . . –0.5 V to 7 V
Input voltage range, V_I (see Note 1) . . . . . –0.5 V to 7 V
Output voltage range, V_O (see Note 1) . . . . . –0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} (V_I < 0) . . . . . –20 mA
Output clamp current, I_{OK} (V_O < 0 or V_O > V_{CC}) . . . . . ±20 mA
Continuous output current, I_O (V_O = 0 to V_{CC}) . . . . . ±25 mA
Continuous current through V_{CC} or GND . . . . . ±75 mA
Package thermal impedance, θ_{JA} (see Note 2): D package . . . . . 73°C/W
(see Note 2): DB package . . . . . 82°C/W
(see Note 2): DGV package . . . . . 120°C/W
(see Note 2): N package . . . . . 67°C/W
(see Note 2): NS package . . . . . 64°C/W
(see Note 2): PW package . . . . . 108°C/W
(see Note 3): RGY package . . . . . 39°C/W
Storage temperature range, T_{stg} . . . . . –65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
2. The package thermal impedance is calculated in accordance with JESD 51-7.
3. The package thermal impedance is calculated in accordance with JESD 51-5.

recommended operating conditions (see Note 4)

		SN54AHCT138		SN74AHCT138		UNIT
		MIN	MAX	MIN	MAX	
V_{CC}	Supply voltage	4.5	5.5	4.5	5.5	V
V_{IH}	High-level input voltage	2		2		V
V_{IL}	Low-level input voltage		0.8		0.8	V
V_I	Input voltage	0	5.5	0	5.5	V
V_O	Output voltage	0	V_{CC}	0	V_{CC}	V
I_{OH}	High-level output current		–8		–8	mA
I_{OL}	Low-level output current		8		8	mA
$\Delta t/\Delta v$	Input transition rise or fall rate		20		20	ns/V
T_A	Operating free-air temperature	–55	125	–40	85	°C

NOTE 4: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V_{CC}	T_A = 25°C			SN54AHCT138		SN74AHCT138		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V_{OH}	I_{OH} = –50 μA	4.5 V	4.4	4.5		4.4		4.4		V
	I_{OH} = –8 mA		3.94			3.8		3.8		
V_{OL}	I_{OL} = 50 μA	4.5 V			0.1		0.1		0.1	V
	I_{OL} = 8 mA				0.36		0.5		0.44	
I_I	V_I = 5.5 V or GND	0 V to 5.5 V			±0.1		±1*		±1	μA
I_{CC}	$V_I = V_{CC}$ or GND, I_O = 0	5.5 V			4		40		40	μA
ΔI_{CC}†	One input at 3.4 V, Other inputs at V_{CC} or GND	5.5 V			1.35		1.5		1.5	mA
C_i	$V_I = V_{CC}$ or GND	5 V		2	10				10	pF

* On products compliant to MIL-PRF-38535, this parameter is not production tested at V_{CC} = 0 V.
† This is the increase in supply current for each input at one of the specified TTL voltage levels rather than 0 V or V_{CC}.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V ± 0.5 V (unless otherwise noted) (see Figure 1)

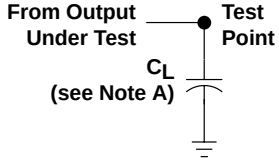
PARAMETER	FROM (INPUT)	TO (OUTPUT)	LOAD CAPACITANCE	T_A = 25°C			SN54AHCT138		SN74AHCT138		UNIT
				MIN	TYP	MAX	MIN	MAX	MIN	MAX	
t_{PLH}	A, B, C	Any Y	C_L = 15 pF		7.6*	10.4*	1*	12*	1	12	ns
t_{PHL}					7.6*	10.4*	1*	12*	1	12	
t_{PLH}	G1	Any Y	C_L = 15 pF		6.6*	9.1*	1*	10.5*	1	10.5	ns
t_{PHL}					6.6*	9.1*	1*	10.5*	1	10.5	
t_{PLH}	$\overline{G}$2A, $\overline{G}$2B	Any Y	C_L = 15 pF		7*	9.6*	1*	11*	1	11	ns
t_{PHL}					7*	9.6*	1*	11*	1	11	
t_{PLH}	A, B, C	Any Y	C_L = 50 pF		8.1	11.4	1	13	1	13	ns
t_{PHL}					8.1	11.4	1	13	1	13	
t_{PLH}	G1	Any Y	C_L = 50 pF		7.1	10.1	1	11.5	1	11.5	ns
t_{PHL}					7.1	10.1	1	11.5	1	11.5	
t_{PLH}	$\overline{G}$2A, $\overline{G}$2B	Any Y	C_L = 50 pF		7.5	10.6	1	12	1	12	ns
t_{PHL}					7.5	10.6	1	12	1	12	

* On products compliant to MIL-PRF-38535, this parameter is not production tested.

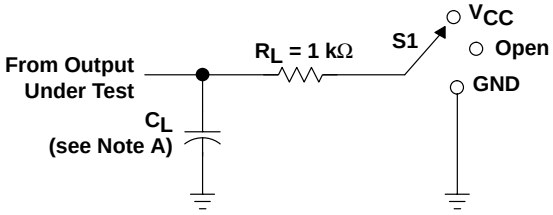
operating characteristics, V_{CC} = 5 V, T_A = 25°C

PARAMETER		TEST CONDITIONS	TYP	UNIT
C_{pd}	Power dissipation capacitance	No load, f = 1 MHz	14	pF

PARAMETER MEASUREMENT INFORMATION

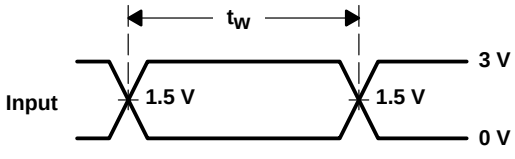


LOAD CIRCUIT FOR
TOTEM-POLE OUTPUTS

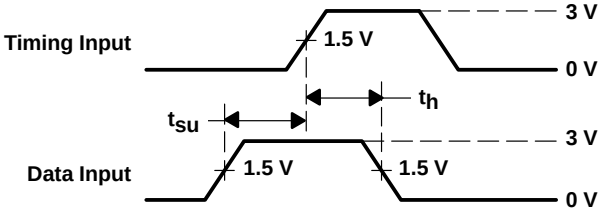


LOAD CIRCUIT FOR
3-STATE AND OPEN-DRAIN OUTPUTS

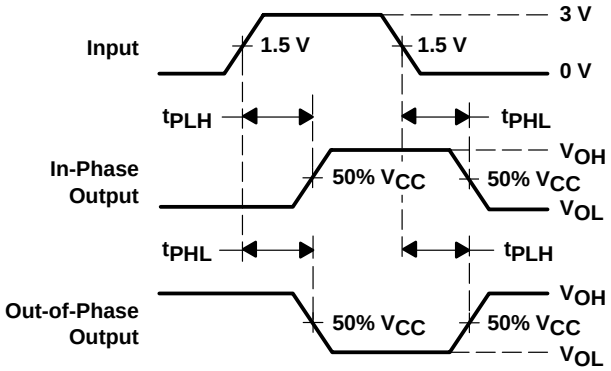
TEST	S1
t_{PLH}/t_{PHL}	Open
t_{PLZ}/t_{PZL}	V_{CC}
t_{PHZ}/t_{PZH}	GND
Open Drain	V_{CC}



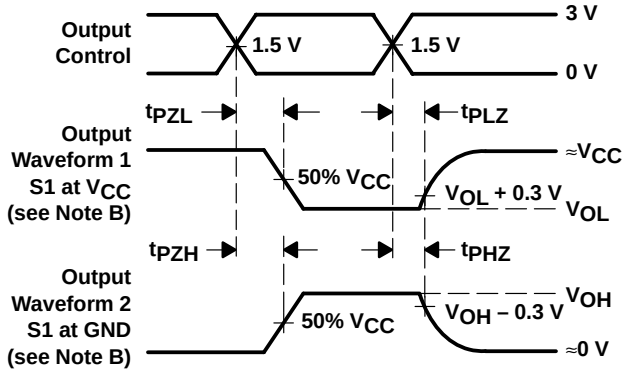
VOLTAGE WAVEFORMS
PULSE DURATION



VOLTAGE WAVEFORMS
SETUP AND HOLD TIMES



VOLTAGE WAVEFORMS
PROPAGATION DELAY TIMES
INVERTING AND NONINVERTING OUTPUTS



VOLTAGE WAVEFORMS
ENABLE AND DISABLE TIMES
LOW- AND HIGH-LEVEL ENABLING

NOTES: A. C_L includes probe and jig capacitance.
B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 1 MHz, Z_O = 50 Ω, t_r ≤ 3 ns, t_f ≤ 3 ns.
D. The outputs are measured one at a time with one input transition per measurement.
E. All parameters and waveforms are not applicable to all devices.

Figure 1. Load Circuit and Voltage Waveforms

APPLICATION INFORMATION

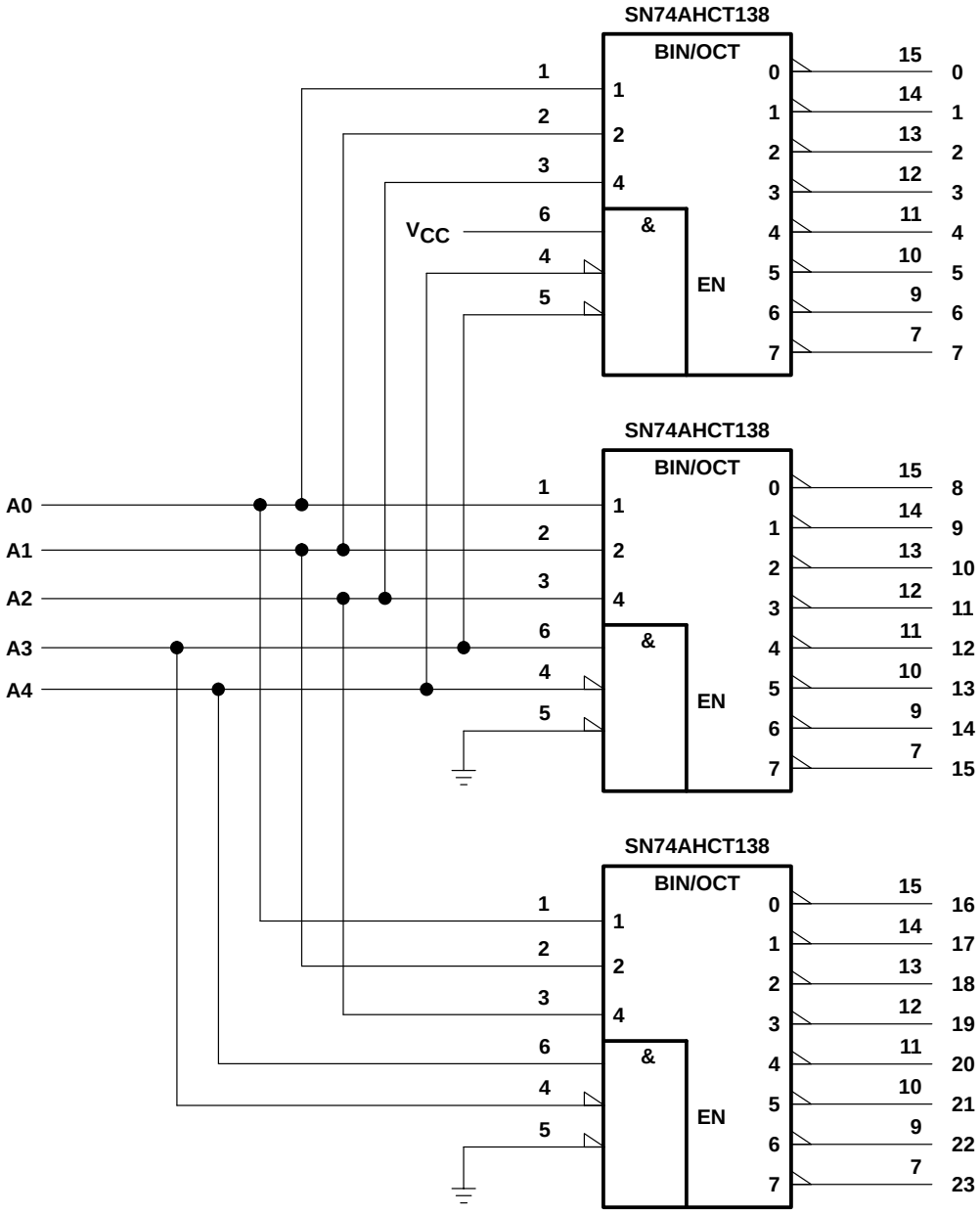


Figure 2. 24-Bit Decoding Scheme

APPLICATION INFORMATION

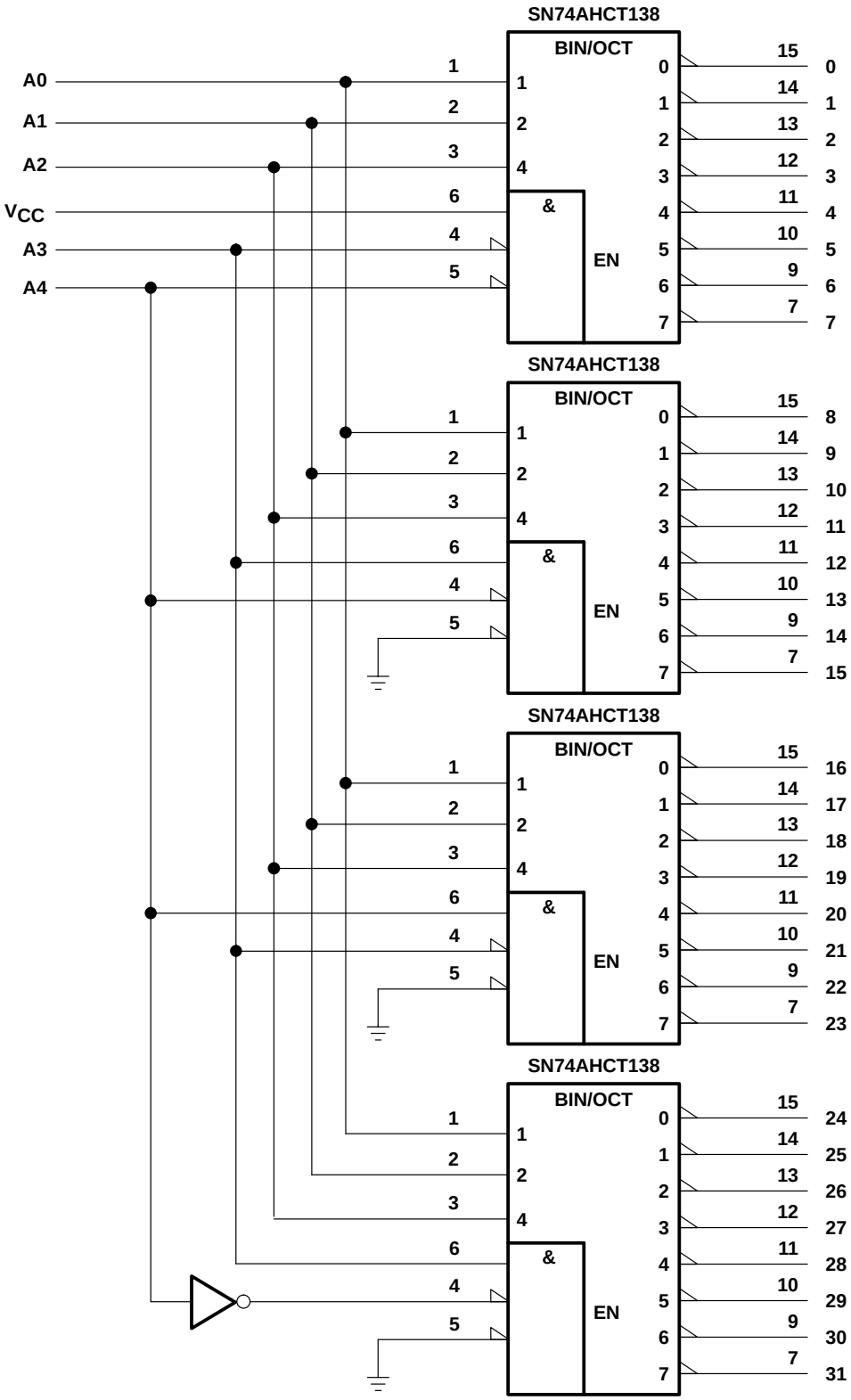


Figure 3. 32-Bit Decoding Scheme

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Mailing Address:

Texas Instruments
Post Office Box 655303
Dallas, Texas 75265

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